

Automotive ASMD Series



Features

- Products meet applicable automotive industry standards
- Compatible with high-volume electronics assembly
- Resettable solution against overcurrent and short-circuit
- AEC-Q200 qualified, RoHS compliant, and ISO/TS16949 certified
- Surface-mount form factor

Additional Information



Datasheet



Resources



Samples

Description

Helping to reduce weight of wire harnesses. PPTC devices distributed in a circuit can allow the use of smaller wire sizes with the resulting harnesses. Forego looping back and forth around a fuse box and place your protection wherever you see fit. The solid state composition of PPTC devices helps provide reliability.

Applications

- Automotive and industrial transportation
- Actuators and medium motors
- Trace protection
- Harness/junction box protection
- Powered outputs
- Electronic control modules
- Telematics/Infotainment

Benefits

- Expertise from the world's leading resettable overcurrent protection manufacturer
- Wide range of dedicated automotive surface-mount and radial-leaded resettable overcurrent devices
- High performance transient voltage protection devices

Electrical Characteristics

Part Number	$I_H(A)@$	$I_H(A)@$	I_T	V_{MAX}	I_{MAX}	P_D Typ	Max Time-to-trip		R_{MIN}	R_{1MAX}	R_{aMAX}
	(R_{1MAX})	(R_{aMAX})					(A)	(V_{DC})			
ASMD – 16-60V											
ASMD030F	0.23	0.23	0.59	60	10	1.1	1.15	12.0	0.980	4.800	4.800
ASMD050F	0.37	0.37	0.98	60	10	1.7	1.95	20.0	0.290	1.400	1.400
ASMD075F	0.60	0.60	1.48	30	40	1.1	3.00	20.0	0.290	1.000	1.000
ASMD100F	0.90	0.90	2.16	30	40	1.1	4.50	20.0	0.098	0.480	0.480
ASMD125F	1.04	1.04	2.46	16	40	1.1	5.20	20.0	0.057	0.250	0.250
ASMD150F	1.27	1.27	2.95	16	40	1.2	6.35	25.0	0.049	0.250	0.250
ASMD150F/33	1.20	1.20	2.88	33	40	1.9	6.00	14.0	0.068	0.230	0.230
ASMD185F	1.85	1.85	3.70	16	40	1.5	9.25	11.3	0.032	0.126	0.126
ASMD200F	1.73	1.73	3.93	16	40	1.2	8.65	30.0	0.050	0.120	0.120
ASMD250F	1.97	1.97	5.00	16	40	1.2	9.85	30.0	0.035	0.085	0.085

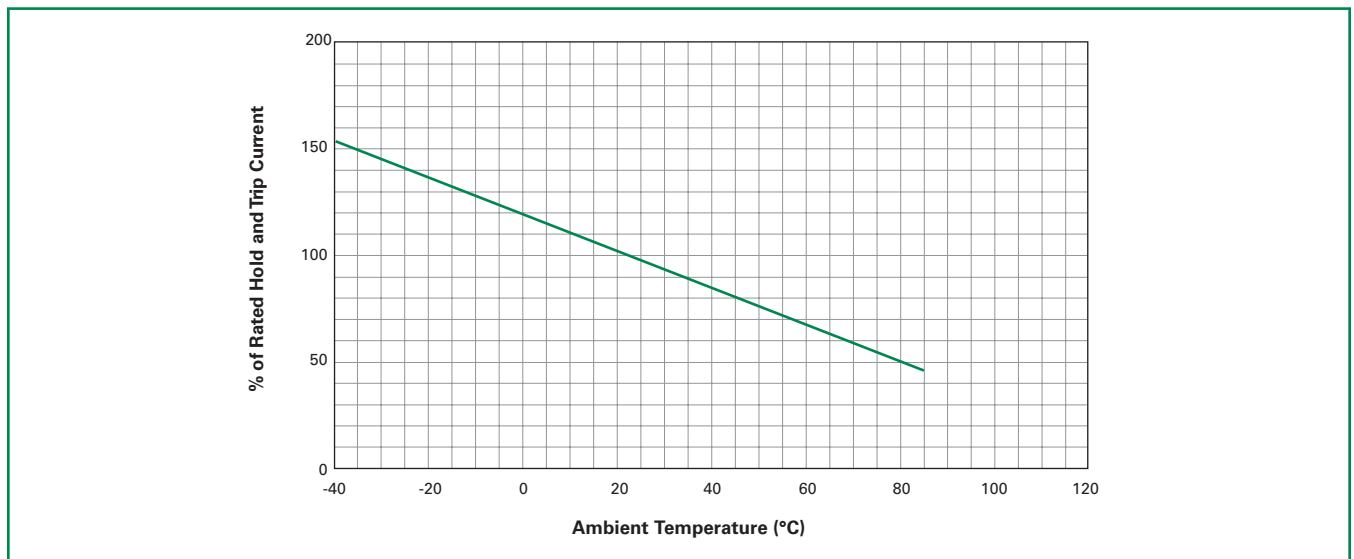
Notes:

- I_H : Hold current: maximum current device will pass without interruption in 25°C, unless otherwise specified
- I_T : Trip current: minimum current that will switch the device from low-resistance to high-resistance in 25°C still air, unless otherwise specified.
- V_{MAX} : Maximum voltage device can withstand without damage at rated current.
- I_{MAX} : Maximum fault current device can withstand without damage at rated voltage.
- P_D : Power dissipated from device when in the tripped state in 25°C still air, unless otherwise specified.
- R_{MIN} : Minimum resistance of device as supplied at 25°C, unless otherwise specified.
- R_{1MAX} : Maximum resistance of device when measured one hour post reflow, unless otherwise specified.
- R_{aMAX} : Maximum functional resistance of device after being subjected to the stresses described in PS400 at 25°C, unless otherwise specified.

Temperature Derating

Maximum Ambient Temperature										
Part Number	-40°C	-20°C	0°C	20°C	25°C	40°C	50°C	60°C	70°C	85°C
Hold Current (A)										
ASMD – 16-60V										
ASMD030F	0.35	0.31	0.27	0.23	0.22	0.19	0.17	0.15	0.13	0.11
ASMD050F	0.59	0.53	0.46	0.39	0.37	0.33	0.29	0.26	0.23	0.18
ASMD075F	0.91	0.81	0.71	0.60	0.58	0.50	0.45	0.40	0.35	0.28
ASMD100F	1.37	1.22	1.06	0.90	0.86	0.76	0.68	0.60	0.52	0.41
ASMD125F	1.58	1.40	1.23	1.04	1.00	0.87	0.78	0.70	0.60	0.48
ASMD150F	1.93	1.70	1.50	1.27	1.22	1.07	0.95	0.85	0.74	0.58
ASMD150F/33	1.96	1.73	1.50	1.26	1.20	1.03	0.91	0.80	0.68	0.51
ASMD185F	2.93	2.58	2.30	1.93	1.85	1.62	1.44	1.30	1.12	0.88
ASMD200F	2.63	2.34	2.04	1.73	1.66	1.45	1.30	1.16	1.00	0.80
ASMD250F	3.00	2.66	2.32	1.97	1.89	1.65	1.48	1.32	1.14	0.91

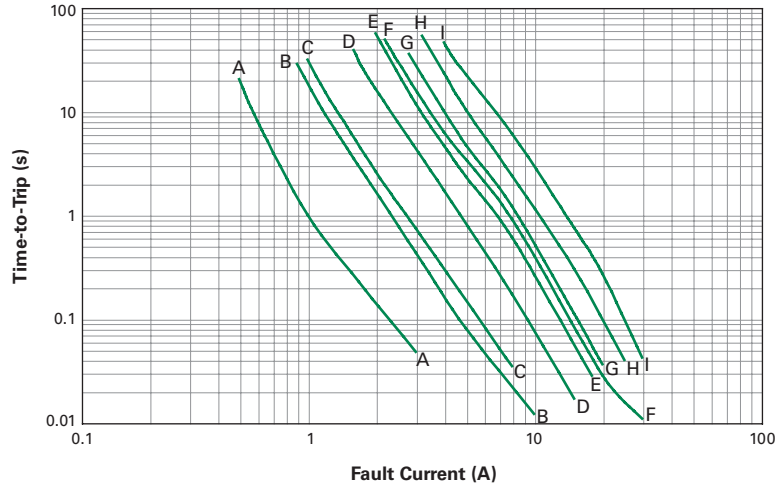
Temperature Derating Curve



Typical Time-to-Trip Curves at 25°C

ASMD

- A = ASMD030F
- B = ASMD050F
- C = ASMD075F
- D = ASMD100F
- E = ASMD125F
- F = ASMD150F, ASMD150F/33
- G = ASMD185F
- H = ASMD200F
- I = ASMD250F



Physical Specifications

Terminal Pad Material	98%+ Tin-plated Brass
Soldering Characteristics	Solderability per ANSI-J-STD-002 Category 1
Solder Heat Withstand	per IEC 60068-2-20, Test Tb, Section 5, Method 1a
Flammability Resistance	per IEC 60695-11-5 Needle Flame Test for 20 seconds
Recommended Storage Conditions	40°C max, 70% RH max; Devices May Not Meet Specified Ratings if Storage Conditions are Exceeded
Operation Temperature	-40°C~85°C

Note: See PS400 for other physical specifications.

Environmental Specifications

Test	Conditions	Resistance Change
Passive Aging	60°C, 1000 hrs	±3% Typical
	85°C, 1000 hrs	±5% Typical
Humidity Aging	85°C, 85% R.H., 100 hrs	±1.2% Typical
Thermal Shock	85°C, -40°C 20 times	-33% Typical
	125°C, -55°C 10 times	-33% Typical
Solvent Resistance	Freon	No change
	Trichloroethane	No change
	Hydrocarbons	No change

Note: See PS400 for other environmental specifications.

Moisture Resistance Level	Level 2a, J-STD-020
Storage Conditions	40°C max, 70% RH max; devices should remain in original sealed bags prior to use. Devices may not meet specified values if these storage conditions are exceeded.

Dimension Figures

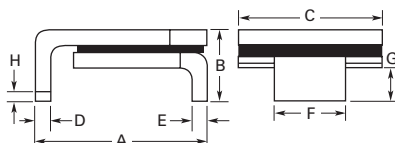
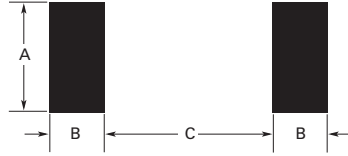


Figure 1

Dimensions

Part Number	Dimensions in Millimeters (Inches)																Figure
	A		B		C		D		E		F		G		H		
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
ASMD – 16-60V																	
ASMD030F	6.73 (0.265)	7.98 (0.314)	—	3.18 (0.125)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	—	1
ASMD050F	6.73 (0.265)	7.98 (0.314)	—	3.18 (0.125)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	—	1
ASMD075F	6.73 (0.265)	7.98 (0.314)	—	3.18 (0.125)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	—	1
ASMD100F	6.73 (0.265)	7.98 (0.314)	—	3.00 (0.118)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	—	1
ASMD125F	6.73 (0.265)	7.98 (0.314)	—	3.00 (0.118)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	—	1
ASMD150F	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.0 (0.24)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	—	1
ASMD150F/33	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.0 (0.24)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	—	1
ASMD185F	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.0 (0.24)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	—	1
ASMD200F	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.0 (0.24)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	—	1
ASMD250F	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.0 (0.24)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	—	1

Recommended Pad Layout



Packaging and Marking Information

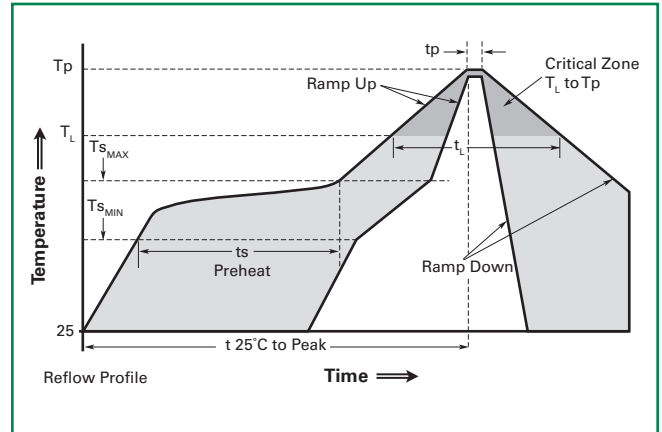
Part Number	Tape and Reel Quantity	Standard Package	Part Marking	Recommended Pad Layout Figures [mm (in)]		
				Dimension A (Min*/Nom)	Dimension B (Nom)	Dimension C (Nom)
ASMD – 16-60V						
ASMD030F	2,000	10,000	030F	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)
ASMD050F	2,000	10,000	050F	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)
ASMD075F	2,000	10,000	075F	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)
ASMD100F	2,000	10,000	100F	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)
ASMD125F	2,000	10,000	125F	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)
ASMD150F	1,500	7,500	150F	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)
ASMD150F/33	1,500	7,500	153F	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)
ASMD185F	1,500	7,500	185A	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)
ASMD200F	1,500	7,500	200F	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)
ASMD250F	1,500	7,500	250F	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)

* These devices are intended for use in automotive applications.

Solder Reflow Recommendations

Profile Feature	Pb-Free Assembly
Average ramp up rate (T_{S_MAX} to T_p)	3°C/s max
Preheat	
• Temperature min (T_{S_MIN})	150°C
• Temperature max (T_{S_MAX})	200°C
• Time (t_{S_MIN} to t_{S_MAX})	60-120 s
Time maintained above:	
• Temperature (T_L)	217°C
• Time (t_L)	60-150 s
Peak/Classification temperature (T_p)	260°C
Time within 5°C of actual peak temperature	
Time (t_p)	30 s max
Ramp down rate	3°C/s max
Time 25°C to peak temperature	8 min max

Note: All temperatures refer to topside of the package, measured on the package body surface.



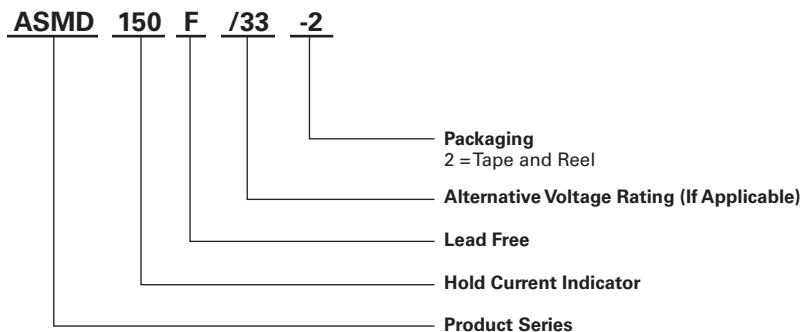
Solder Reflow

- Recommended reflow method: IR, hot air, nitrogen.
- Recommended maximum paste thickness: 0.25mm (0.010in)
- Devices can be cleaned using standard methods and aqueous solvents.
- Experience has shown the optimum conditions for forming acceptable solder fillets occur when a reasonable amount of solder paste is placed underneath each device's termination. As such, we request that customers comply with our recommended solder pad layouts.
- Customer should validate that the solder paste amount and reflow recommendations meet its application.
- We request that customer board layouts refrain from placing raised features (e.g. vias, nomenclature, traces, etc.) underneath PolySwitch devices. It is possible that raised features could negatively impact solderability performance of our devices.

Rework

- Standard industry practices. (Please also avoid direct contact to the device.)

Part Ordering Number System



Tape and Reel Specifications

Description	ASMD EIA 481-2	
	ASMD030F ASMD050F ASMD075F ASMD100F ASMD125F	ASMD150F ASMD150F/33 ASMD185F ASMD200F ASMD250F
W	16.0 ± 0.30	16.0 ± 0.30
P₀	4.0 ± 0.10	4.0 ± 0.10
P₁	8.0 ± 0.10	12.0 ± 0.10
P₂	2.0 ± 0.10	2.0 ± 0.10
A₀	5.6 ± 0.23	6.9 ± 0.23
B₀	8.1 ± 0.15	9.6 ± 0.15
B₁ max	12.1	12.1
D₀	1.5 + 0.10/ -0.00	1.5 + 0.10/ -0.00
F	750 ± 0.10	750 ± 0.10
E₁	1.75 ± 0.10	1.75 ± 0.10
E₂ min	14.25	14.25
T max	0.4	0.4
T₁ max	0.1	0.1
K₀	3.2 ± 0.15	3.4 ± 0.15
A max	330	330
N min	50	50
W₁	16.4 + 2.0/-0.00	16.4 + 2.0/-0.00
W₂ max	22.4	22.4

Tape and Reel Diagrams

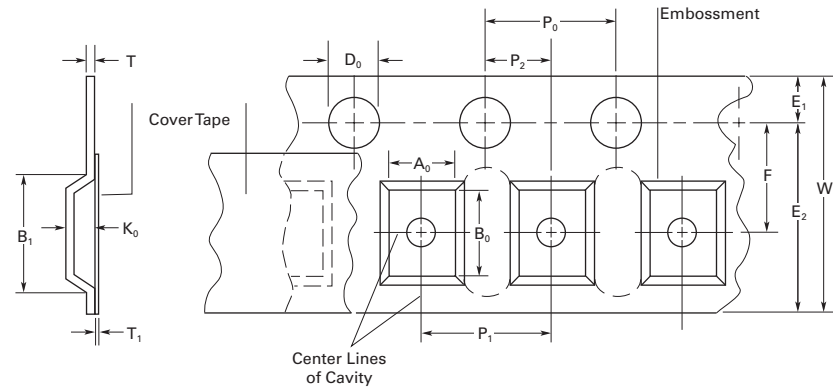


Figure 1

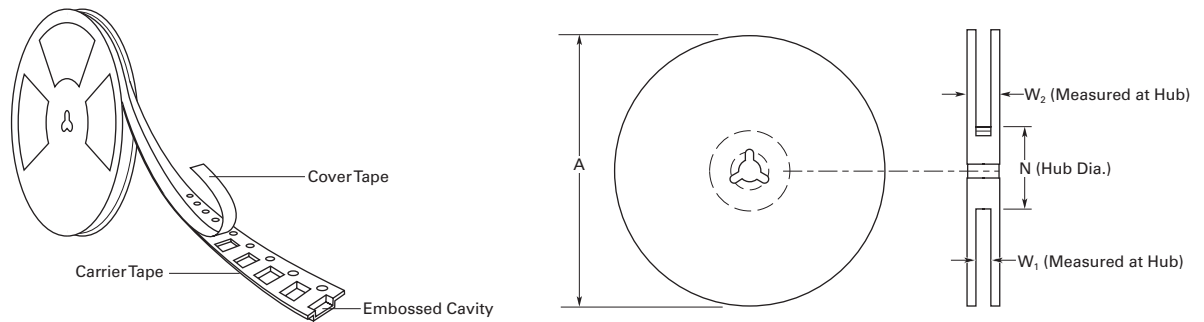


Figure 2

WARNING

- Users should independently evaluate the suitability of and test each product selected for their own application.
- Operation beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- These devices are intended for protection against damage caused by occasional overcurrent or overtemperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Contamination of the PPTC material with certain silicone-based oils or some aggressive solvents can adversely impact the performance of the devices.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
- PPTC devices are not recommended for installation in applications where the device is constrained such that its PTC properties are inhibited, for example in rigid potting materials or in rigid housings, which lack adequate clearance to accommodate device expansion.
- Operation in circuits with a large inductance can generate a circuit voltage (Ldi/dt) above the rated voltage of the device.

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